TOSHIBA Photocoupler GaAlAs Ired & Photo IC

# **TLP559**

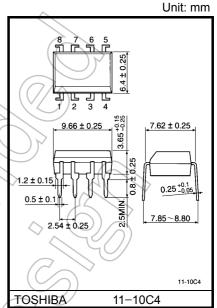
Digital Logic Ground Isolation Line Receiver Microprocessor System Interfaces Switching Power Supply Feedback Control Transistor Inverter

The TOSHIBA TLP559 consists of a GaAlAs high-output light emitting diode and a high speed detector of one chip photo diode-transistor. This unit is 8-lead DIP package.

TLP559 has no internal base connection, and a Faraday shield integrated on the photodetector chip provides an effective common mode noise transient immunity.

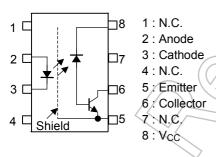
So this is suitable for application in noisy environmental condition.

- Isolation voltage: 2500 Vrms (min)
- Switching speed:  $t_{pHL} = 0.3\mu s$  (typ.)  $t_{pLH} = 0.5\mu s$  (typ.) (R<sub>L</sub> = 1.9k $\Omega$ )
- TTL compatible
- UL recognized: UL1577, file No.E67349

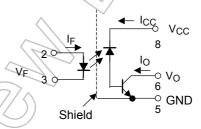


Weight: 0.54 g (typ.)

### Pin Configuration (top view)



### **Schematic**



#### Absolute Maximum Ratings (Ta = 25°C)

	Characteristic		Symbol	Rating	Unit
	Forward current	(Note 1)	lF	25	mA
	Pulse forward current	(Note 2)	I <sub>FP</sub>	50	mA
LED	Peak transient forward current	(Note 3)	I <sub>FPT</sub>	1	Α
	Reverse voltage		V <sub>R</sub>	5	V
	Diode power dissipation	(Note 4)	P <sub>D</sub>	45	mW
	Output current		lo /	8	mA
ō	Peak output current		TOP	16	mA
Detector	Output voltage		Vo	–0.5 to 15	V
	Supply voltage		Vcc	0.5 to 15	V
	Output power dissipation	(Note 5)	Po	100	mW
Оре	rating temperature range	_	Topr	-55 to 100	(°C)
Storage temperature range		(7	T <sub>stg</sub>	-55 to 125	°C
Lea	d solder temperature (10s)	(Note 6)	T <sub>sol</sub>	260	(°C)
Isola	ation voltage (AC, 1 minute, R.H. ≤ 60%)	(Note 7)	BVS	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- (Note 1) Derate 0.8mA above 70°C.
- (Note 2) 50% duty cycle,1ms pulse width. Derate 1.6mA / °C above 70°C.
- (Note 3) Pulse width  $\leq 1\mu s$ , 300pps.
- (Note 4) Derate 0.9mW / °C above 70°C.
- (Note 5) Derate 2mW / °C above 70°C.
- (Note 6) Soldering portion of lead: up to 2mm from body of the devise.
- (Note 7) Device considered a two-terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

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#### **Electrical Characteristics (Ta = 25°C)**

Characteristic		Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 16mA	_	1.65	1.85	V
LED	Forward voltage temperature coefficient	ΔV <sub>F</sub> / ΔTa	I <sub>F</sub> = 16mA	_	-2	-	mV / °C
=	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5V	1	_	10	μΑ
	Capacitance between terminal	C <sub>T</sub>	V <sub>F</sub> = 0, f = 1MHz		45	_	pF
Detector	High level output current	I <sub>OH</sub> (1)	I <sub>F</sub> = 0mA, V <sub>CC</sub> = V <sub>O</sub> = 5.5V		) 3	500	nA
		I <sub>OH</sub> (2)	I <sub>F</sub> = 0mA, V <sub>CC</sub> = V <sub>O</sub> = 15V	7 <del>4</del>	_	5	
		Іон	I <sub>F</sub> = 0mA, V <sub>CC</sub> = 15V V <sub>O</sub> = 15V, Ta = 70°C	))	-	50	μA
	High level supply voltage	Іссн	I <sub>F</sub> = 0mA, V <sub>CC</sub> = 15V	· _	0.01	1	μΑ
	Supply voltage	V <sub>CC</sub>	I <sub>CC</sub> = 0.01 mA	15		_	V
	Output voltage	VO	I <sub>O</sub> = 0.5 mA	15	4	$\rightarrow$	V

### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	l o /l=	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, V_O = 0.4 \text{ V}$	20	40		- %
Current transfer fatto	I <sub>O</sub> /I <sub>F</sub>	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, V_O = 0.4 \text{ V}, Ta = 0 \text{ to } 70^{\circ}\text{C}$	15	_	_	
Low level output voltage	V <sub>OL</sub>	$I_F = 16 \text{ mA}, V_{CC} = 4.5 \text{ V}, I_O = 2.4 \text{ mA}$	1	_	0.4	<b>V</b>

### Isolation Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit		
Capacitance (input-output)	7/c <sub>s</sub>	$V_S = 0$ , $f = 1$ MHz (Note 7	) —	8.0	_	pF		
Resistance (input-output)	Rs	R.H. $\leq$ 60%, V <sub>S</sub> = 500 V <sub>DC</sub> (Note 7	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω		
		AC, 1 minute	2500	_		V		
Isolation voltage	BVs	AC, 1 second, in oil	_	5000	_	V <sub>rms</sub>		
		DC, 1 minute, in oil	_	5000	_	$V_{dc}$		

## Switching Characteristics (Ta = $25^{\circ}$ C, V<sub>CC</sub> = 5V)

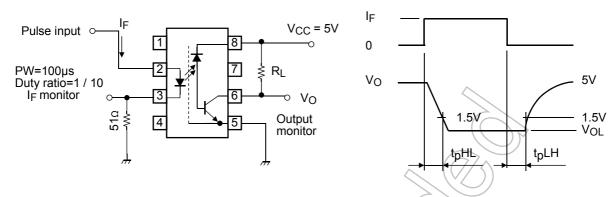
Characteristic	^	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Propagation delay time	(H-)	tpHL	1	$I_{\rm F} = 16$ mA, $R_{\rm I} = 1.9$ k $\Omega$	_	0.2	8.0	μs
Propagation delay time	(L→ H)	\t <sub>pLH</sub>	'	1F - 10111A, N 1.3N22	ı	0.3	8.0	μs
Common mode transient im at logic high output	munity (Note 8)	СМН	2	$I_F = 0$ mA, $V_{CM} = 400V_{p-p}$ R <sub>L</sub> = 4.1k $\Omega$	2000	10000	1	V / µs
Common mode transient im at logic high output	munity (Note 8)	CML	2	$I_F$ =16mA, $V_{CM}$ = 400 $V_{p-p}$ R <sub>L</sub> = 4.1k $\Omega$	-2000	-10000	_	V / µs

(Note 8)  $CM_L$  is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state ( $V_O < 0.8V$ ).

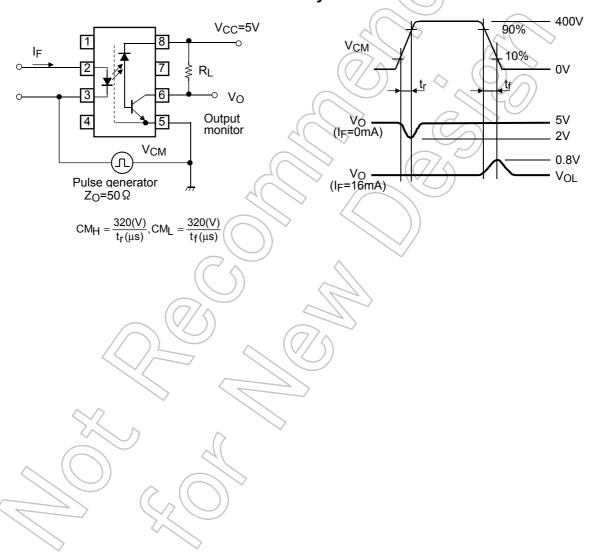
 $CM_H$  is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state ( $V_O > 2.0V$ ).

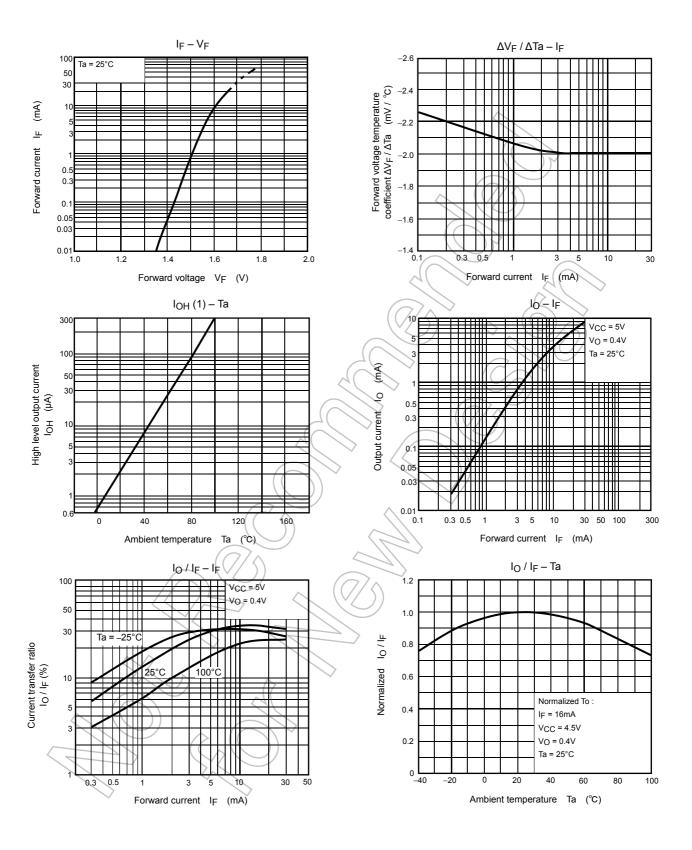
(Note 9) Maximum electrostatic discharge voltage for any pins: 100V (C = 200pF, R = 0)

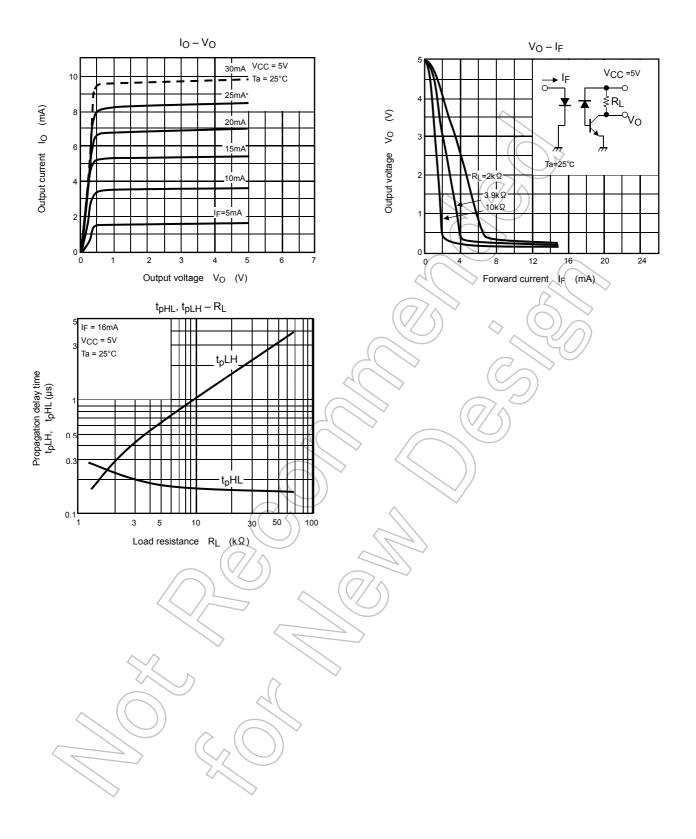
### **Test Circuit 1: Switching Time Test Circuit**



### Test Circuit 2: Common Mode Noise Immunity Test Circuit







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